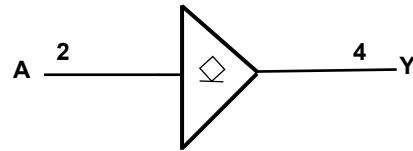


## Pin Descriptions

| Pin Name        | Description    |
|-----------------|----------------|
| NC              | No Connection  |
| A               | Data Input     |
| GND             | Ground         |
| Y               | Data Output    |
| V <sub>CC</sub> | Supply Voltage |

## Logic Diagram



## Function Table

| Input | Output |
|-------|--------|
| A     | Y      |
| H     | Z      |
| L     | L      |

## Absolute Maximum Ratings (Notes 4 & 5) (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol                            | Description   | Rating       | Unit |
|-----------------------------------|---|--------------|------|
| ESD HBM                           | Human Body Model ESD Protection                                       | 2            | kV   |
| ESD CDM                           | Charged Device Model ESD Protection                                   | 1            | kV   |
| V <sub>CC</sub>                   | Supply Voltage Range  | -0.5 to 6.5  | V    |
| V <sub>I</sub>                    | Input Voltage Range   | -0.5 to 6.5  | V    |
| V <sub>O</sub>                    | Voltage Applied to Output in High Impedance or I <sub>OFF</sub> State | -0.5 to 6.5  | V    |
| V <sub>O</sub>                    | Voltage Applied to Output in High or Low State                        | --0.5 to 6.5 | V    |
| I <sub>IK</sub>                   | Input Clamp Current V <sub>I</sub> < 0                                | -50          | mA   |
| I <sub>OK</sub>                   | Output Clamp Current  | -50          | mA   |
| I <sub>O</sub>                    | Continuous Output Current   | 50           | mA   |
| I <sub>CC</sub> , I <sub>GN</sub> | Continuous Current Through V <sub>CC</sub> or GND                     | ±100         | mA   |
| T <sub>J</sub>                    | Operating Junction Temperature  | -40 to +150  | °C   |
| T <sub>STG</sub>                  | Storage Temperature   | -65 to +150  | °C   |

- Notes:
- Stresses beyond the absolute maximum can result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
  - Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or, conversely, forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

**Recommended Operating Conditions** (Note 6) (@  $T_A = +25^{\circ}\text{C}$ , unless otherwise specified.)

| Symbol              | Parameter                          |  | Min                  | Max                  | Unit               |
|---------------------|------------------------------------|--|----------------------|----------------------|--------------------|
| $V_{CC}$            | Operating Voltage                  | Operating  | 1.65                 | 5.5                  | V                  |
|                     |                                    | Data retention only  | 1.5                  | —                    | V                  |
| $V_{IH}$            | High-Level Input Voltage           | $V_{CC} = 1.65\text{V to }1.95\text{V}$                              | $0.65 \times V_{CC}$ | —                    | V                  |
|                     |                                    | $V_{CC} = 2.3\text{V to }2.7\text{V}$                                | 1.7                  | —                    |                    |
|                     |                                    | $V_{CC} = 3\text{V to }3.6\text{V}$                                  | 2                    | —                    |                    |
|                     |                                    | $V_{CC} = 4.5\text{V to }5.5\text{V}$                                | $0.7 \times V_{CC}$  | —                    |                    |
| $V_{IL}$            | Low-Level Input Voltage            | $V_{CC} = 1.65\text{V to }1.95\text{V}$                              | —                    | $0.35 \times V_{CC}$ | V                  |
|                     |                                    | $V_{CC} = 2.3\text{V to }2.7\text{V}$                                | —                    | 0.7                  |                    |
|                     |                                    | $V_{CC} = 3\text{V to }3.6\text{V}$                                  | —                    | 0.8                  |                    |
|                     |                                    | $V_{CC} = 4.5\text{V to }5.5\text{V}$                                | —                    | $0.3 \times V_{CC}$  |                    |
| $V_I$               | Input Voltage                      |  | 0                    | 5.5                  | V                  |
| $V_O$               | Output Voltage                     |  | 0                    | 5.5                  | V                  |
| $I_{OL}$            | Low-Level Output Current           | $V_{CC} = 1.65\text{V}$  | —                    | 4                    | mA                 |
|                     |                                    | $V_{CC} = 2.3\text{V}$   | —                    | 8                    |                    |
|                     |                                    | $V_{CC} = 2.7\text{V}$   | —                    | 12                   |                    |
|                     |                                    | $V_{CC} = 3\text{V}$   | —                    | 16                   |                    |
|                     |                                    | $V_{CC} = 4.5\text{V}$   | —                    | 24                   |                    |
| $\Delta t/\Delta V$ | Input Transition Rise or Fall Rate | $V_{CC} = 1.8\text{V} \pm 0.15\text{V}, 2.5\text{V} \pm 0.2\text{V}$ | —                    | 20                   | ns/V               |
|                     |                                    | $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$                               | —                    | 10                   |                    |
|                     |                                    | $V_{CC} = 5\text{V} \pm 0.5\text{V}$                                 | —                    | 5                    |                    |
| $T_A$               | Operating Free-Air Temperature     |  | —                    | —                    | $^{\circ}\text{C}$ |

Note: 6. Unused inputs should be held at  $V_{CC}$  or Ground.

**Electrical Characteristics** (All typical values are at  $V_{CC} = 3.3V$ ,  $T_A = +25^\circ C$ .)

| Symbol          | Parameter                  | Test Conditions                  | $V_{CC}$      | -40°C to +85°C |           |          | -40°C to +125°C |          | Unit    |
|-----------------|----------------------------|----------------------------------|---------------|----------------|-----------|----------|-----------------|----------|---------|
|                 |                            |                                  |               | Min            | Typ       | Max      | Min             | Max      |         |
| $V_{OL}$        | Low Level Output Voltage   | $I_{OL} = 100\mu A$              | 1.65V to 5.5V | —              | —         | 0.1      | —               | 0.1      | V       |
|                 |                            | $I_{OL} = 4mA$                   | 1.65V         | —              | —         | 0.45     | —               | 0.45     |         |
|                 |                            | $I_{OL} = 8mA$                   | 2.3V          | —              | —         | 0.3      | —               | 0.3      |         |
|                 |                            | $I_{OL} = 12mA$                  | 2.7V          | —              | —         | 0.4      | —               | 0.6      |         |
|                 |                            | $I_{OL} = 16mA$                  | 3V            | —              | —         | 0.4      | —               | 0.4      |         |
|                 |                            | $I_{OL} = 24mA$                  |               | —              | —         | 0.55     | —               | 0.55     |         |
|                 |                            | $I_{OL} = 32mA$                  | 4.5V          | —              | —         | 0.55     | —               | 0.55     |         |
| $I_I$           | Input Current              | $V_I = 5.5V$ or GND              | 0 to 5.5V     | —              | $\pm 0.1$ | $\pm 5$  | —               | $\pm 5$  | $\mu A$ |
| $I_{OFF}$       | Power Down Leakage Current | $V_I$ or $V_O = 5.5V$            | 0V            | —              | —         | $\pm 10$ | —               | $\pm 10$ | $\mu A$ |
| $I_{CC}$        | Supply Current             | $V_I = 5.5V$ or GND<br>$I_O = 0$ | 5.5V          | —              | 0.1       | 10       | —               | 10       | $\mu A$ |
| $\Delta I_{CC}$ | Additional Supply Current  | Input at $V_{CC} - 0.6V$         | 3V to 5.5V    | —              | —         | 500      | —               | 500      | $\mu A$ |
| $C_I$           | Input Capacitance          | $V_I = V_{CC}$ or GND            | 3.3V          | —              | 5         | —        | —               | —        | pF      |

**Package Characteristics** (All typical values are at  $V_{CC} = 3.3V$ ,  $T_A = +25^\circ C$ .)

| Symbol        | Parameter                              | Test Conditions       | $V_{CC}$ | Min | Typ | Max | Unit         |
|---------------|--|-----------------------|----------|-----|-----|-----|--------------|
| $\theta_{JA}$ | Thermal Resistance Junction-to-Ambient | SOT25                 | (Note 7) | —   | 204 | —   | $^\circ C/W$ |
|               |  | SOT353                |          | —   | 371 | —   |              |
|               |  | SOT553                |          | —   | 231 | —   |              |
|               |  | X2-DFN0808-4          |          | —   | 400 | —   |              |
|               |  | X1-DFN1010-6 (Type B) |          | —   | 435 | —   |              |
|               |  | X2-DFN1010-6          |          | —   | 445 | —   |              |
|               |  | X2-DFN1409-6          |          | —   | 470 | —   |              |
|               |  | X2-DFN1410-6          |          | —   | 460 | —   |              |
| $\theta_{JC}$ | Thermal Resistance Junction-to-Case    | SOT25                 | (Note 7) | —   | 52  | —   | $^\circ C/W$ |
|               |  | SOT353                |          | —   | 143 | —   |              |
|               |  | SOT553                |          | —   | 105 | —   |              |
|               |  | X2-DFN0808-4          |          | —   | 225 | —   |              |
|               |  | X1-DFN1010-6 (Type B) |          | —   | 250 | —   |              |
|               |  | X2-DFN1010-6          |          | —   | 250 | —   |              |
|               |  | X2-DFN1409-6          |          | —   | 275 | —   |              |
|               |  | X2-DFN1410-6          |          | —   | 265 | —   |              |

Note: 7. Test condition for each of the 8 package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

## Switching Characteristics

Figure 1 Typical Values at  $T_A = +25^\circ\text{C}$  and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

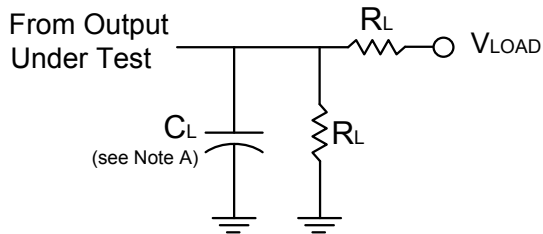
| Parameter | From Input | To Output | $V_{CC}$                       | $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ |     |     | $T_A = -40^\circ\text{C to } +125^\circ\text{C}$ |     | Unit |
|-----------|------------|-----------|--------------------------------|---|-----|-----|--|-----|------|
|           |            |           |                                | Min   | Typ | Max | Min  | Max |      |
| $t_{PD}$  | A or B     | Y         | $1.8\text{V} \pm 0.15\text{V}$ | 1.0   | 3.0 | 6.5 | 1.0  | 8.5 | ns   |
|           |            |           | $2.5\text{V} \pm 0.2\text{V}$  | 0.5   | 1.9 | 4.0 | 0.5  | 5.5 |      |
|           |            |           | 2.7V                           | 0.5   | 2.5 | 4.5 | 0.5  | 6.0 |      |
|           |            |           | $3.3\text{V} \pm 0.3\text{V}$  | 0.5   | 2.3 | 4.0 | 0.5  | 5.5 |      |
|           |            |           | $5.0\text{V} \pm 0.5\text{V}$  | 0.5   | 1.7 | 3.0 | 0.5  | 4.0 |      |

## Operating Characteristics

$T_A = +25^\circ\text{C}$

| Parameter |                               | Test Conditions    | $V_{CC} = 1.8\text{V}$ | $V_{CC} = 2.5\text{V}$ | $V_{CC} = 3.3\text{V}$ | $V_{CC} = 5\text{V}$ | Unit |
|-----------|-------------------------------|--------------------|------------------------|------------------------|------------------------|----------------------|------|
|           |                               |                    | Typ                    | Typ                    | Typ                    | Typ                  |      |
| $C_{PD}$  | Power Dissipation Capacitance | $f = 10\text{MHz}$ | 3                      | 3                      | 4                      | 6                    | pF   |

## Parameter Measurement Information



| TEST                    | Condition  |
|-------------------------|------------|
| $t_{PLZ}$ (Notes D & F) | $V_{LOAD}$ |
| $t_{PZL}$ (Notes D & E) | $V_{LOAD}$ |

| $V_{CC}$         | Inputs   |              | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|------------------|----------|--------------|------------|-------------------|-------|--------------|--------------|
|                  | $V_I$    | $t_R/t_F$    |            |                   |       |              |              |
| $1.8V \pm 0.15V$ | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF  | 1k $\Omega$  | 0.15V        |
| $2.5V \pm 0.2V$  | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF  | 500 $\Omega$ | 0.15V        |
| 2.7V             | 2.7V     | $\leq 2.5ns$ | 1.5V       | 6V                | 50pF  | 500 $\Omega$ | 0.3V         |
| $3.3V \pm 0.3V$  | 3V       | $\leq 2.5ns$ | 1.5V       | 6V                | 50pF  | 500 $\Omega$ | 0.3V         |
| $5V \pm 0.5V$    | $V_{CC}$ | $\leq 2.5ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50pF  | 500 $\Omega$ | 0.3V         |

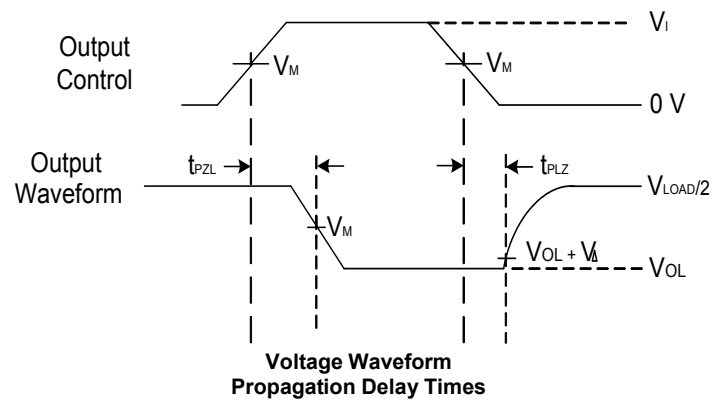
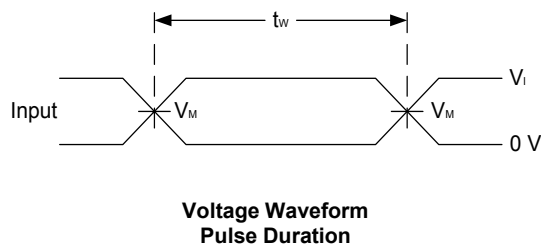
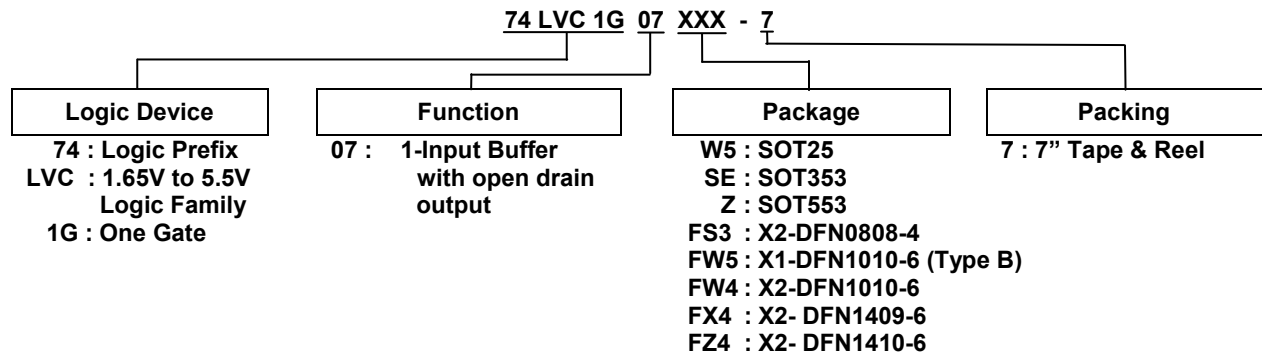


Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
  - B. All pulses are supplied at pulse repetition rate  $\leq 10MHz$ .
  - C. The inputs are measured one at a time with one transition per measurement.
  - D. For the open drain device  $t_{PLZ}$  and  $t_{PZL}$  are the same as  $t_{PD}$ .
  - E.  $t_{PZL}$  is measured at  $V_M$ .
  - F.  $t_{PLZ}$  is measured at  $V_{OL} + V_{\Delta}$ .

**Ordering Information** (Note 8)


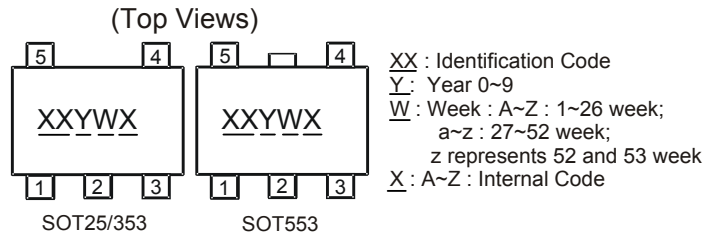
| Part Number    | Package Code | Package (Notes 9 & 10)                 | 7" Tape and Reel  |                    |
|----------------|--------------|--|-------------------|--------------------|
|                |              |  | Quantity          | Part Number Suffix |
| 74LVC1G07W5-7  | W5           | SOT25                                  | 3,000/Tape & Reel | -7                 |
| 74LVC1G07SE-7  | SE           | SOT353                                 | 3,000/Tape & Reel | -7                 |
| 74LVC1G07Z-7   | Z            | SOT553                                 | 4,000/Tape & Reel | -7                 |
| 74LVC1G07FS3-7 | FS3          | X2-DFN0808-4                           | 5,000/Tape & Reel | -7                 |
| 74LVC1G07FW5-7 | FW5          | X1-DFN1010-6 (Type B)                  | 5,000/Tape & Reel | -7                 |
| 74LVC1G07FW4-7 | FW4          | X2-DFN1010-6                           | 5,000/Tape & Reel | -7                 |
| 74LVC1G07FX4-7 | FX4          | X2-DFN1409-6<br>Chip scale alternative | 5,000/Tape & Reel | -7                 |
| 74LVC1G07FZ4-7 | FZ4          | X2-DFN1410-6                           | 5,000/Tape & Reel | -7                 |

Notes:

8. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
9. Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
10. The taping orientation is located on our website at <https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf>.

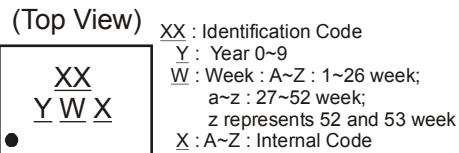
## Marking Information

### (1) SOT25, SOT353 and SOT553



| Part Number   | Package | Identification Code |
|---------------|---------|---------------------|
| 74LVC1G07W5-7 | SOT25   | UN                  |
| 74LVC1G07SE-7 | SOT353  | UN                  |
| 74LVC1G07Z-7  | SOT553  | UN                  |

### (2) DFN Packages

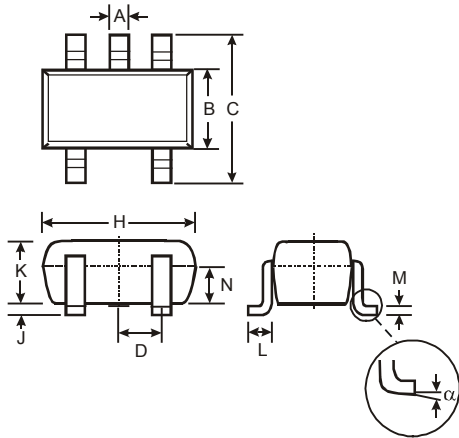


| Part Number    | Package               | Identification Code |
|----------------|-----------------------|---------------------|
| 74LVC1G07FS3-7 | X2-DFN0808-4          | WN                  |
| 74LVC1G07FW5-7 | X1-DFN1010-6 (Type B) | V6                  |
| 74LVC1G07FW4-7 | X2-DFN1010-6          | UN                  |
| 74LVC1G07FX4-7 | X2-DFN1409-6          | ME                  |
| 74LVC1G07FZ4-7 | X2-DFN1410-6          | UN                  |

## Package Outline Dimensions

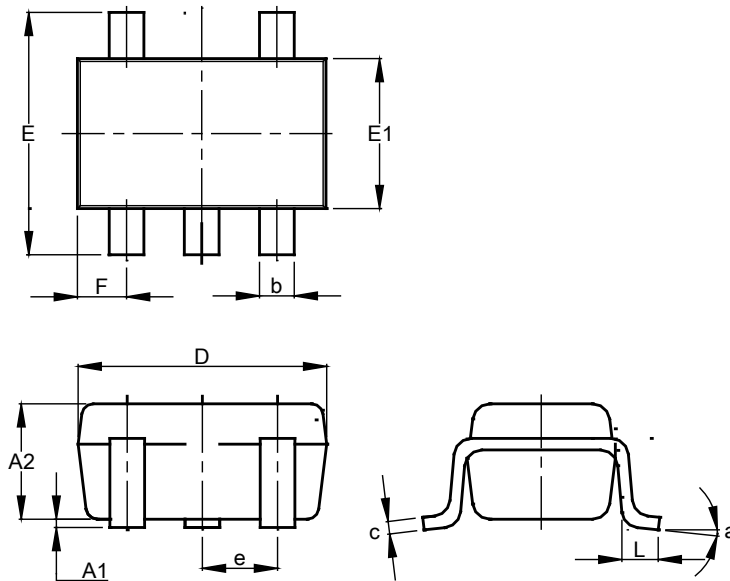
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT25



| SOT25                |       |      |      |
|----------------------|-------|------|------|
| Dim                  | Min   | Max  | Typ  |
| A                    | 0.35  | 0.50 | 0.38 |
| B                    | 1.50  | 1.70 | 1.60 |
| C                    | 2.70  | 3.00 | 2.80 |
| D                    | -     | -    | 0.95 |
| H                    | 2.90  | 3.10 | 3.00 |
| J                    | 0.013 | 0.10 | 0.05 |
| K                    | 1.00  | 1.30 | 1.10 |
| L                    | 0.35  | 0.55 | 0.40 |
| M                    | 0.10  | 0.20 | 0.15 |
| N                    | 0.70  | 0.80 | 0.75 |
| $\alpha$             | 0°    | 8°   | -    |
| All Dimensions in mm |       |      |      |

### (2) Package Type: SOT353



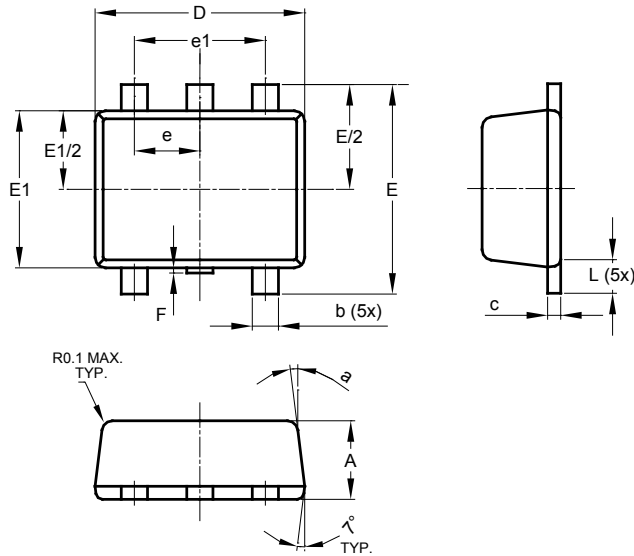
| SOT353               |           |      |       |
|----------------------|-----------|------|-------|
| Dim                  | Min       | Max  | Typ   |
| A1                   | 0.00      | 0.10 | 0.05  |
| A2                   | 0.90      | 1.00 | 0.95  |
| b                    | 0.10      | 0.30 | 0.25  |
| c                    | 0.10      | 0.22 | 0.11  |
| D                    | 1.80      | 2.20 | 2.15  |
| E                    | 2.00      | 2.20 | 2.10  |
| E1                   | 1.15      | 1.35 | 1.30  |
| e                    | 0.650 BSC |      |       |
| F                    | 0.40      | 0.45 | 0.425 |
| L                    | 0.25      | 0.40 | 0.30  |
| a                    | 0°        | 8°   | --    |
| All Dimensions in mm |           |      |       |



## Package Outline Dimensions (continued)

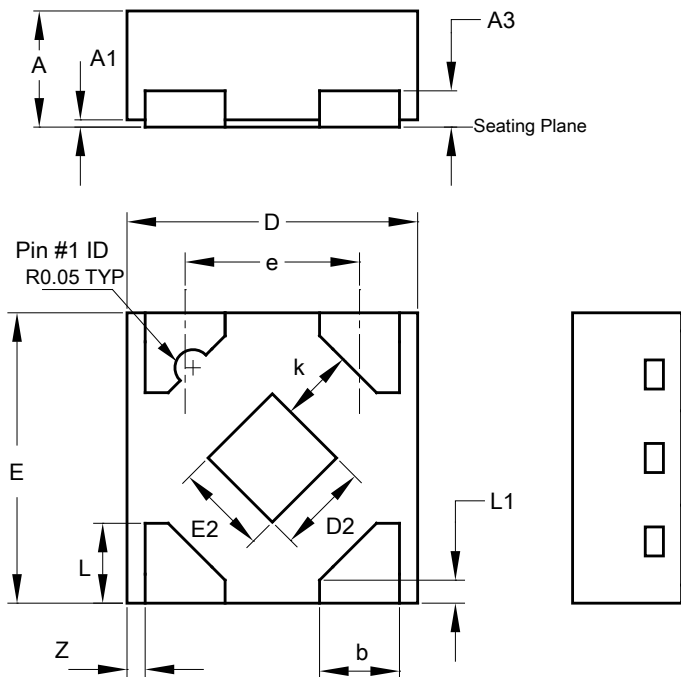
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (3) Package Type: SOT553



| SOT553               |          |      |      |
|----------------------|----------|------|------|
| Dim                  | Min      | Max  | Typ  |
| A                    | 0.55     | 0.62 | 0.60 |
| b                    | 0.15     | 0.30 | 0.20 |
| c                    | 0.10     | 0.18 | 0.15 |
| D                    | 1.50     | 1.70 | 1.60 |
| E                    | 1.55     | 1.70 | 1.60 |
| E1                   | 1.10     | 1.25 | 1.20 |
| e                    | 0.50 BSC |      |      |
| e1                   | 1.00 BSC |      |      |
| F                    | 0.00     | 0.10 | —    |
| L                    | 0.10     | 0.30 | 0.20 |
| a                    | 6°       | 8°   | 7°   |
| All Dimensions in mm |          |      |      |

### (4) Package Type: X2-DFN0808-4

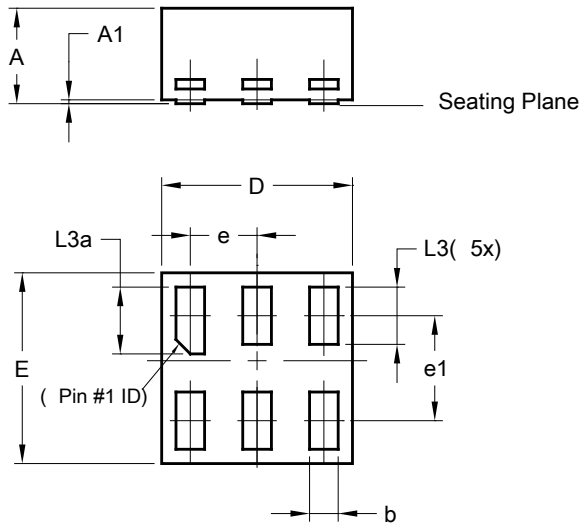


| X2-DFN0808-4         |      |      |      |
|----------------------|------|------|------|
| Dim                  | Min  | Max  | Typ  |
| A                    | 0.25 | 0.35 | 0.30 |
| A1                   | 0    | 0.04 | 0.02 |
| A3                   | -    | -    | 0.13 |
| b                    | 0.17 | 0.27 | 0.22 |
| D                    | 0.75 | 0.85 | 0.80 |
| D2                   | 0.15 | 0.35 | 0.25 |
| E                    | 0.75 | 0.85 | 0.80 |
| E2                   | 0.15 | 0.35 | 0.25 |
| e                    | -    | -    | 0.48 |
| k                    | 0.20 | -    | -    |
| L                    | 0.17 | 0.27 | 0.22 |
| L1                   | 0.02 | 0.12 | 0.07 |
| z                    | -    | -    | 0.05 |
| All Dimensions in mm |      |      |      |

## Package Outline Dimensions (continued)

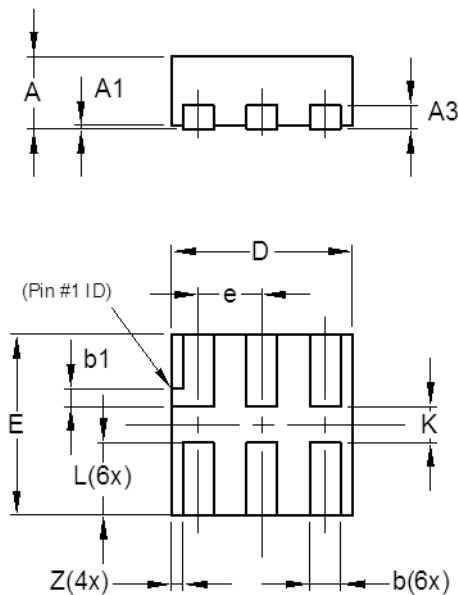
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (5) Package Type: X1-DFN1010-6 (Type B)



| X1-DFN1010-6<br>(Type B) |          |       |      |
|--------------------------|----------|-------|------|
| Dim                      | Min      | Max   | Typ  |
| A                        | -        | 0.50  | 0.39 |
| A1                       | -        | 0.04  | -    |
| b                        | 0.12     | 0.20  | 0.15 |
| D                        | 0.95     | 1.050 | 1.00 |
| E                        | 0.95     | 1.050 | 1.00 |
| e                        | 0.35 BSC |       |      |
| e1                       | 0.55 BSC |       |      |
| L3                       | 0.27     | 0.30  | 0.30 |
| L3a                      | 0.32     | 0.40  | 0.35 |
| All Dimensions in mm     |          |       |      |

### (6) Package Type: X2-DFN1010-6

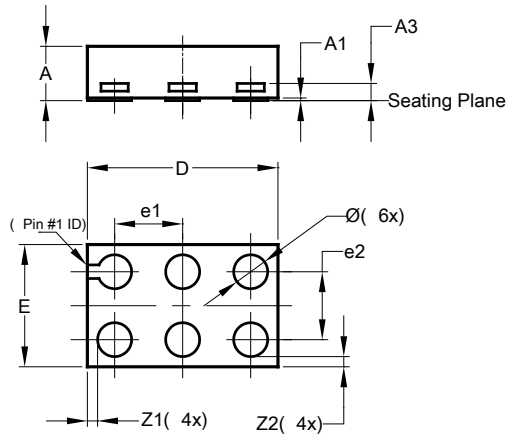


| X2-DFN1010-6         |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | —    | 0.40 | 0.39  |
| A1                   | 0.00 | 0.05 | 0.02  |
| A3                   | —    | —    | 0.13  |
| b                    | 0.14 | 0.20 | 0.17  |
| b1                   | 0.05 | 0.15 | 0.10  |
| D                    | 0.95 | 1.05 | 1.00  |
| E                    | 0.95 | 1.05 | 1.00  |
| e                    | —    | —    | 0.35  |
| L                    | 0.35 | 0.45 | 0.40  |
| K                    | 0.15 | —    | —     |
| Z                    | —    | —    | 0.065 |
| All Dimensions in mm |      |      |       |

## Package Outline Dimensions (continued)

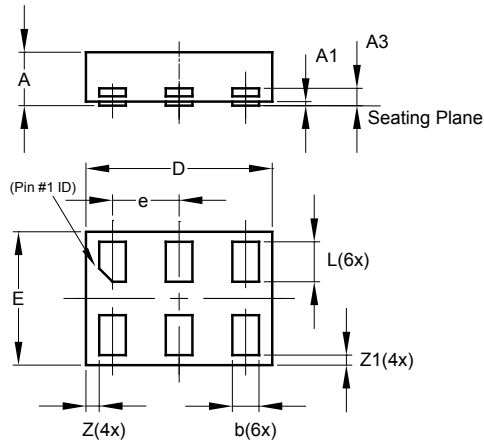
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (7) Package Type: X2-DFN1409-6



| X2-DFN1409-6         |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | -    | 0.40 | 0.39  |
| A1                   | 0    | 0.05 | 0.02  |
| A3                   | -    | -    | 0.13  |
| Ø                    | 0.20 | 0.30 | 0.25  |
| D                    | 1.35 | 1.45 | 1.40  |
| E                    | 0.85 | 0.95 | 0.90  |
| e1                   | -    | -    | 0.50  |
| e2                   | -    | -    | 0.50  |
| Z1                   | -    | -    | 0.075 |
| Z2                   | -    | -    | 0.075 |
| All Dimensions in mm |      |      |       |

### (8) Package Type: X2-DFN1410-6

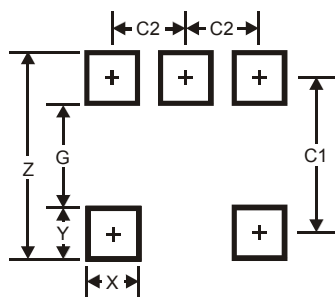


| X2-DFN1410-6         |       |       |       |
|----------------------|-------|-------|-------|
| Dim                  | Min   | Max   | Typ   |
| A                    | —     | 0.40  | 0.39  |
| A1                   | 0.00  | 0.05  | 0.02  |
| A3                   | —     | —     | 0.13  |
| b                    | 0.15  | 0.25  | 0.20  |
| D                    | 1.35  | 1.45  | 1.40  |
| E                    | 0.95  | 1.05  | 1.00  |
| e                    | —     | —     | 0.50  |
| L                    | 0.25  | 0.35  | 0.30  |
| Z                    | —     | —     | 0.10  |
| Z1                   | 0.045 | 0.105 | 0.075 |
| All Dimensions in mm |       |       |       |

## Suggested Pad Layout

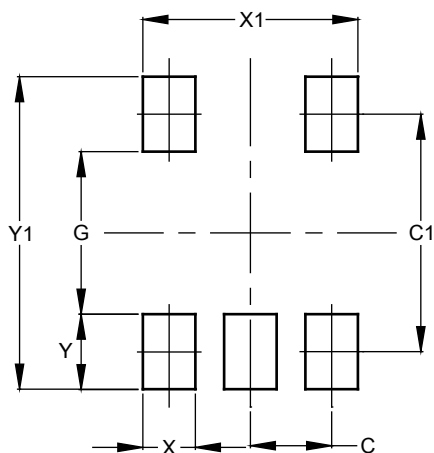
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT25



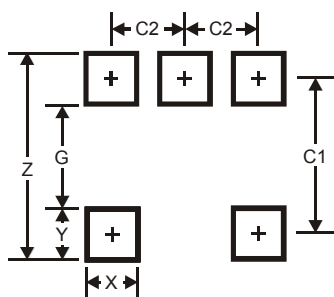
| Dimensions | Value |
|------------|-------|
| Z          | 3.20  |
| G          | 1.60  |
| X          | 0.55  |
| Y          | 0.80  |
| C1         | 2.40  |
| C2         | 0.95  |

### (2) Package Type: SOT353



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.650         |
| C1         | 1.900         |
| G          | 1.300         |
| X          | 0.420         |
| X1         | 1.720         |
| Y          | 0.600         |
| Y1         | 2.500         |

### (3) Package Type: SOT553

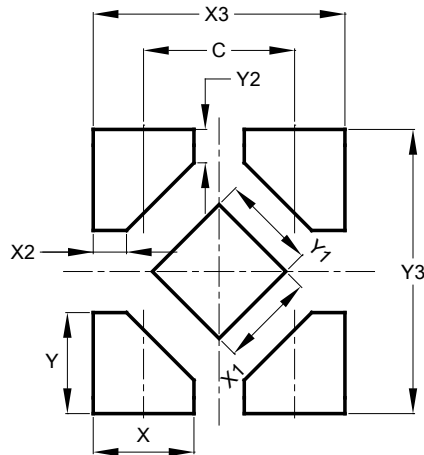


| Dimensions | Value |
|------------|-------|
| Z          | 2.2   |
| G          | 1.2   |
| X          | 0.375 |
| Y          | 0.5   |
| C1         | 1.7   |
| C2         | 0.5   |

## Suggested Pad Layout (continued)

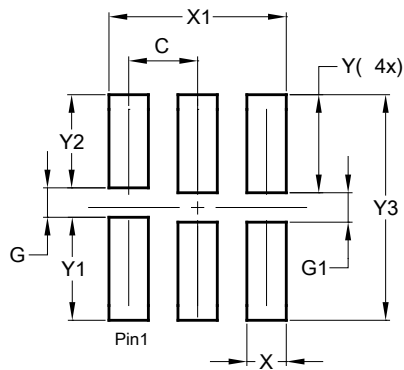
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (4) Package Type: X2-DFN0808-4



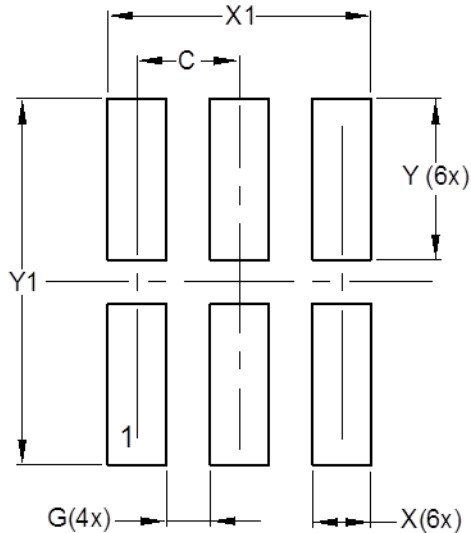
| Dimensions | Value |
|------------|-------|
| C          | 0.480 |
| X          | 0.320 |
| X1         | 0.300 |
| X2         | 0.106 |
| X3         | 0.800 |
| Y          | 0.320 |
| Y1         | 0.300 |
| Y2         | 0.106 |
| Y3         | 0.900 |

### (5) Package Type: X1-DFN1010-6 (Type B)



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.350         |
| G          | 0.150         |
| G1         | 0.150         |
| X          | 0.200         |
| X1         | 0.900         |
| Y          | 0.500         |
| Y1         | 0.525         |
| Y2         | 0.475         |
| Y3         | 1.150         |

### (6) Package Type: X2-DFN1010-6

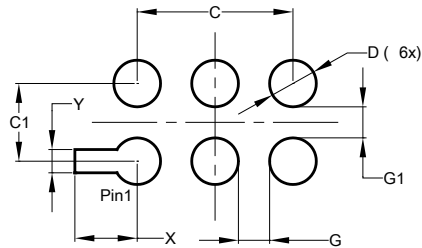


| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.350         |
| G          | 0.150         |
| X          | 0.200         |
| X1         | 0.900         |
| Y          | 0.550         |
| Y1         | 1.250         |

## Suggested Pad Layout (continued)

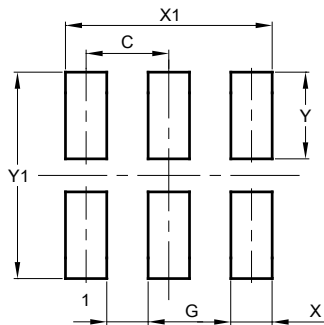
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (7) Package Type: X2-DFN1409-6



| Dimensions | Value (in mm) |
|------------|---------------|
| <b>C</b>   | 1.000         |
| <b>C1</b>  | 0.500         |
| <b>D</b>   | 0.300         |
| <b>G</b>   | 0.200         |
| <b>G1</b>  | 0.200         |
| <b>X</b>   | 0.400         |
| <b>Y</b>   | 0.150         |

### (8) Package Type: X2-DFN1410-6



| Dimensions | Value (in mm) |
|------------|---------------|
| <b>C</b>   | 0.500         |
| <b>G</b>   | 0.250         |
| <b>X</b>   | 0.250         |
| <b>X1</b>  | 1.250         |
| <b>Y</b>   | 0.525         |
| <b>Y1</b>  | 1.250         |

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## Mechanical Data

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### SOT25

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 [e3](#)
- Weight: 0.016 grams (Approximate)

### SOT353

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 [e3](#)
- Weight: 0.006 grams (Approximate)

### SOT553

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 [e3](#)
- Weight: 0.003 grams (Approximate)

### X2-DFN0808-4

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 [e4](#)
- Weight: 0.001 grams (Approximate)

### X1-DFN1010-6 (Type B)

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 [e4](#)
- Weight: 0.001 grams (Approximate)

### X2-DFN1010-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 [e4](#)
- Weight: 0.001 grams (Approximate)

### X2-DFN1409-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 [e4](#)
- Weight: 0.002 grams (Approximate)

### X2-DFN1410-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 [e4](#)
- Weight: 0.002 grams (Approximate)

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